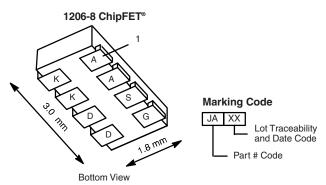


Vishay Siliconix

P-Channel 1.8 V (G-S) MOSFET with Schottky Diode

MOSFET PRODUCT SUMMARY					
V _{DS} (V)	R_{DS(on)} (Ω)	I _D (A)			
	0.110 at V _{GS} = - 4.5 V	- 3.6			
- 20	0.160 at V _{GS} = - 2.5 V	- 3.0			
	0.240 at V _{GS} = - 1.8 V	- 2.4			

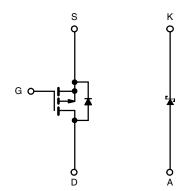
SCHOTTKY PRODUCT SUMMARY				
V _{KA} (V)	V _f (V) Diode Forward Voltage	I _F (A)		
20	0.48 V at 0.5 A	1.0		



FEATURES

- Halogen-free According to IEC 61249-2-21
 Definition
- LITTLE FOOT[®] Plus
- Compliant to RoHS Directive 2002/95/EC





P-Channel MOSFET

Ordering Information: Si5853DC-T1-E3 (Lead (Pb)-free)

Si5853DC-T1-GE3 (Lead (Pb)-free and Halogen-free)

ABSOLUTE MAXIMUM RATINGS T_A = 25 °C, unless otherwise noted Symbol **Steady State** Unit Parameter 5 s Drain-Source Voltage (MOSFET and Schottky) V_{DS} v - 20 Reverse Voltage (Schottky) V_{KA} 20 V Gate-Source Voltage (MOSFET) V_{GS} ± 8 ± 8 T_A = 25 °C - 2.7 - 3.6 Continuous Drain Current (T_J = 150 °C) (MOSFET)^a I_D T_A = 85 °C - 2.6 - 1.9 Pulsed Drain Current (MOSFET) IDM - 10 Α Continuous Source Current (MOSFET Diode Conduction)^a Is - 1.8 - 0.9 Average Forward Current (Schottky) I_{F} 1.0 Pulsed Forward Current (Schottky) I_{FM} 7 $T_A = 25 C$ 2.1 1.1 Maximum Power Dissipation (MOSFET)^a T_A = 85 °C 1.1 0.6 P_D w T_A = 25 °C 0.96 1.3 Maximum Power Dissipation (Schottky)^a T_A = 85 °C 0.68 0.59 Operating Junction and Storage Temperature Range - 55 to 150 T_J, T_{stg} °C 260 Soldering Recommendations (Peak Temperature)^{b, c}

Notes:

a. Surface mounted on 1" x 1" FR4 board.

b. See reliability manual for profile. The ChipFET is a leadless package. The end of the lead terminal is exposed copper (not plated) as a result of the singulation process in manufacturing. A solder fillet at the exposed copper tip cannot be guaranteed and is not required to ensure adequate bottom side solder interconnection.

c. Rework conditions: manual soldering with a soldering iron is not recommended for leadless components.

Document Number: 71239 S10-0547-Rev. D, 08-Mar-10

Vishay Siliconix



THERMAL RESISTANCE RATINGS								
Parameter		Device	Symbol	Typical	Maximum	Unit		
	t ≤ 5 s	MOSFET		50	60			
	1 2 3 8	Schottky	R _{thJA}	77	95			
Junction-to-Ambient ^a	Ctoody Ctoto	MOSFET	''thJA	90	110	°C/W		
	Steady State	Schottky		110	60 95			
Junction-to-Foot	Ctoody Ctoto	MOSFET	R _{thJF}	30	40			
JUNCION-IO-FOOL	Steady State	Schottky	' 'thJF	33	40			

Notes:

a. Surface mounted on 1" x 1" FR4 board.

Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit	
Static	•						
Gate Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_{D} = -250 \ \mu A$	- 0.45		- 1.0	V	
Gate-Body Leakage	I _{GSS}	$V_{DS} = 0 V$, $V_{GS} = \pm 8 V$			± 100	nA	
Zero Gate Voltage Drain Current		$V_{DS} = -20 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$			- 1	μA	
	IDSS	$V_{DS} = -20 \text{ V}, V_{GS} = 0 \text{ V}, T_{J} = 85 ^{\circ}\text{C}$			- 5		
On-State Drain Current ^a	I _{D(on)}	$V_{DS}{\leq}{-}5$ V, $V_{GS}{=}{-}4.5$ V	- 10			Α	
		V_{GS} = - 4.5 V, I_{D} = - 2.7 A		0.095	0.110	Ω	
Drain-Source On-State Resistance ^a	R _{DS(on)}	V_{GS} = - 2.5 V, I_{D} = - 2.2 A		0.137	0.160		
		V _{GS} = - 1.8 V, I _D = - 1 A		0.205	0.240		
Forward Transconductance ^a	9 _{fs}	$V_{DS} = -10 \text{ V}, \text{ I}_{D} = -2.7 \text{ A}$		7		S	
Diode Forward Voltage ^a	V _{SD}	$I_{\rm S}$ = - 0.9 A, $V_{\rm GS}$ = 0 V		- 0.8	- 1.2	V	
Dynamic ^b	<u> </u>						
Total Gate Charge	Qg			5.1	7.7		
Gate-Source Charge	Q _{gs}	V_{DS} = - 10 V, V_{GS} = - 4.5 V, I_{D} = - 2.7 A		1.2		nC	
Gate-Drain Charge	Q _{gd}			1.0			
Turn-On Delay Time	t _{d(on)}			16	25		
Rise Time	t _r	V_{DD} = - 10 V, R_L = 10 Ω		30	45		
Turn-Off Delay Time	t _{d(off)}	$\text{I}_\text{D}\cong$ - 1 A, V_GEN = - 4.5 V, R_g = 6 Ω		30	45	ns	
Fall Time	t _f			27	40		
Source-Drain Reverse Recovery Time	t _{rr}	I _F = - 0.9 A, dl/dt = 100 A/μs		20	40		

Notes:

a. Pulse test; pulse width \leq 300 µs, duty cycle \leq 2 %.

b. Guaranteed by design, not subject to production testing.

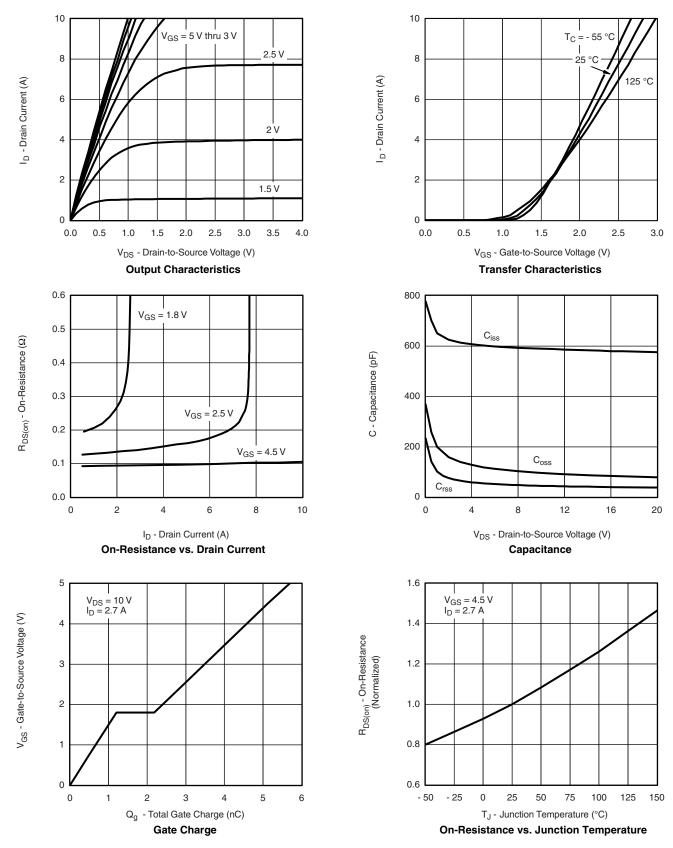
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

SCHOTTKY SPECIFICATIONS $T_J = 25 \text{ °C}$, unless otherwise noted							
Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit	
Forward Voltage Drop	V _F	I _F = 0.5 A		0.42	0.48	v	
		I _F = 0.5 A, T _J = 125 °C		0.33	0.4		
Maximum Reverse Leakage Current		V _r = 20 V	0.00	0.002	0.100	mA	
	I _{rm}	$V_{r} = 20 V, T_{J} = 85 °C$		0.10	1		
		$V_r = 20 \text{ V}, \text{ T}_J = 125 ^\circ\text{C}$		1.5	10		
Junction Capacitance	CT	V _r = 10 V		31		pF	



Vishay Siliconix

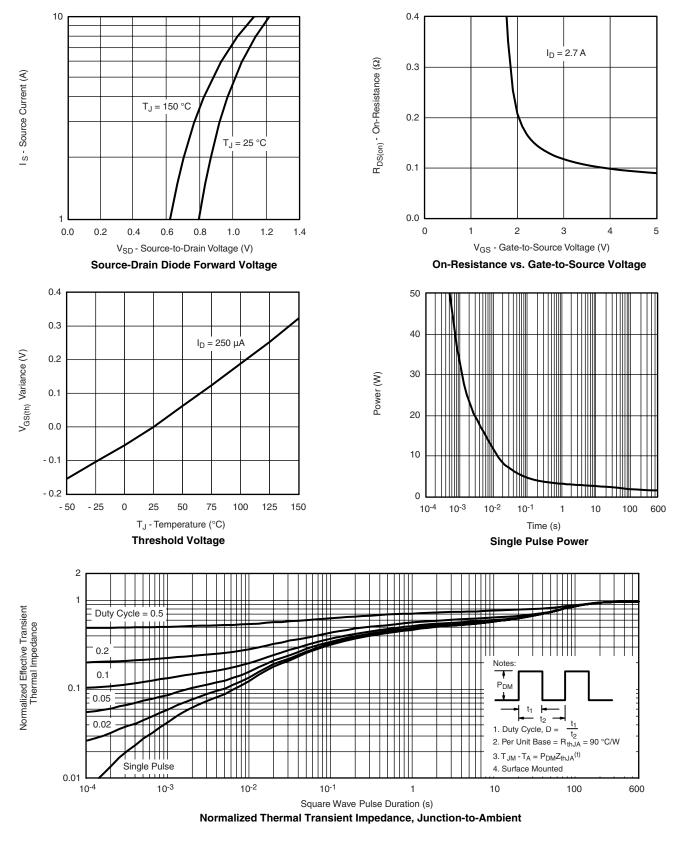
MOSFET TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



Document Number: 71239 S10-0547-Rev. D, 08-Mar-10

Vishay Siliconix





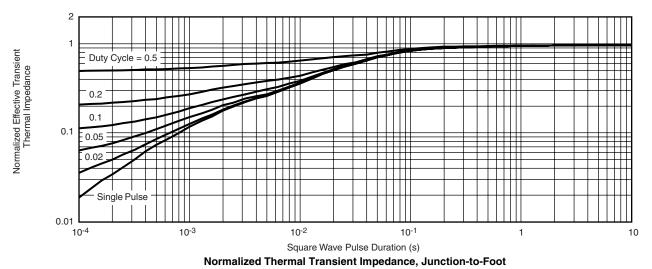
/ISHA



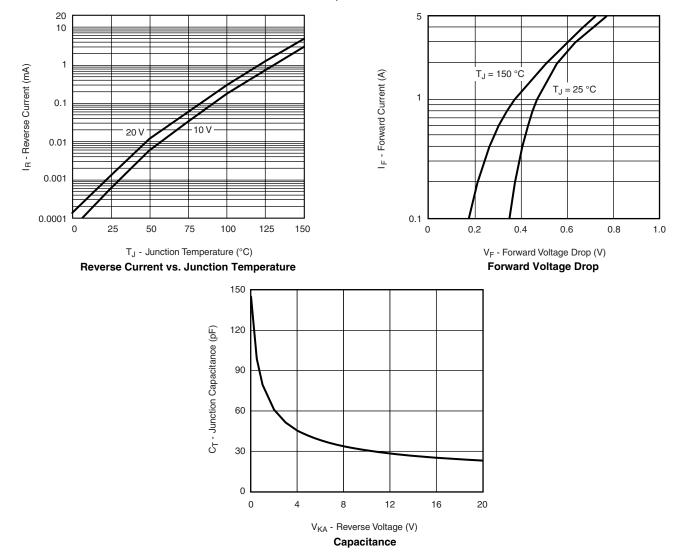


Vishay Siliconix

MOSFET TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

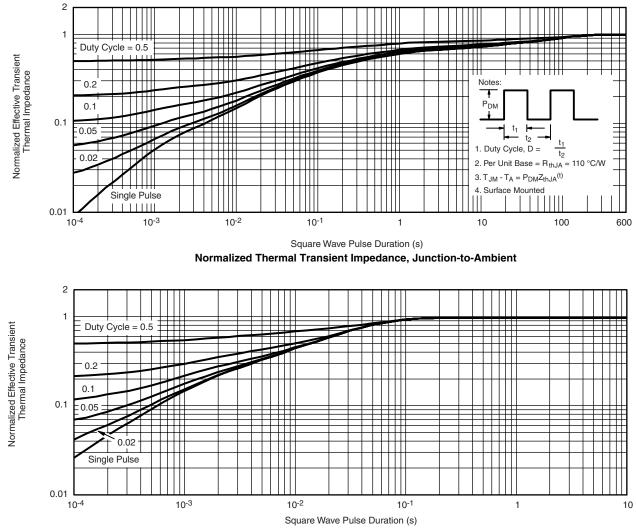






Vishay Siliconix





SCHOTTKY TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

Normalized Thermal Transient Impedance, Junction-to-Foot

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see www.vishay.com/ppg?71239.

www.vishay.com 6



Vishay

Disclaimer

ALL PRODUCT, PRODUCT SPECIFICATIONS AND DATA ARE SUBJECT TO CHANGE WITHOUT NOTICE TO IMPROVE RELIABILITY, FUNCTION OR DESIGN OR OTHERWISE.

Vishay Intertechnology, Inc., its affiliates, agents, and employees, and all persons acting on its or their behalf (collectively, "Vishay"), disclaim any and all liability for any errors, inaccuracies or incompleteness contained in any datasheet or in any other disclosure relating to any product.

Vishay makes no warranty, representation or guarantee regarding the suitability of the products for any particular purpose or the continuing production of any product. To the maximum extent permitted by applicable law, Vishay disclaims (i) any and all liability arising out of the application or use of any product, (ii) any and all liability, including without limitation special, consequential or incidental damages, and (iii) any and all implied warranties, including warranties of fitness for particular purpose, non-infringement and merchantability.

Statements regarding the suitability of products for certain types of applications are based on Vishay's knowledge of typical requirements that are often placed on Vishay products in generic applications. Such statements are not binding statements about the suitability of products for a particular application. It is the customer's responsibility to validate that a particular product with the properties described in the product specification is suitable for use in a particular application. Parameters provided in datasheets and / or specifications may vary in different applications and performance may vary over time. All operating parameters, including typical parameters, must be validated for each customer application by the customer's technical experts. Product specifications do not expand or otherwise modify Vishay's terms and conditions of purchase, including but not limited to the warranty expressed therein.

Hyperlinks included in this datasheet may direct users to third-party websites. These links are provided as a convenience and for informational purposes only. Inclusion of these hyperlinks does not constitute an endorsement or an approval by Vishay of any of the products, services or opinions of the corporation, organization or individual associated with the third-party website. Vishay disclaims any and all liability and bears no responsibility for the accuracy, legality or content of the third-party website or for that of subsequent links.

Except as expressly indicated in writing, Vishay products are not designed for use in medical, life-saving, or life-sustaining applications or for any other application in which the failure of the Vishay product could result in personal injury or death. Customers using or selling Vishay products not expressly indicated for use in such applications do so at their own risk. Please contact authorized Vishay personnel to obtain written terms and conditions regarding products designed for such applications.

No license, express or implied, by estoppel or otherwise, to any intellectual property rights is granted by this document or by any conduct of Vishay. Product names and markings noted herein may be trademarks of their respective owners.